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PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants: MICHAEL S. LEUNG Examiner: Le, Thao X

Serial No. 10/666,399 Art Unit: 2814

Filing Date: September 18, 2003

For: MOLDED CHIP FABRICATION AND APPARATUS

Mail Stop Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

RESPONSE TO NOTICE OF NON-COMPLIANT AMENDMENT

Sir:

In response to the examiner's Notice of Non-Compliant Amendment (37 CFR 1.121), dated March 31, 2005, the attached replacement drawings (Figs. 1 and 2) have now been labeled "Replacement Sheets", pursuant to the examiner's request.

Respectfully submitted,

Dated: 4/4/05

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